

**Amendments to the Specification:**

Please replace the CROSS-REFERENCE TO RELATED APPLICATION section on page one with the following:

This application is a divisional application of U.S. Patent Application No. 10/190,019, entitled "MICROELECTRONIC DEVICE PACKAGES AND METHODS FOR CONTROLLING THE DISPOSITION OF NON-CONDUCTIVE MATERIALS IN SUCH PACKAGES", filed July 5, 2002, now U.S. Patent No. 6,673,649, issued on January 6, 2004, which is incorporated herein by reference in its entirety.